MPSA92 is a Preferred Device

# **High Voltage Transistors**

## **PNP Silicon**



• Pb-Free Packages are Available\*

## **MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Collector - Emitter Voltage  MPSA93  MPSA92	V <sub>CEO</sub>	-200 -300	Vdc
Collector – Base Voltage  MPSA93  MPSA92	V <sub>CBO</sub>	-200 -300	Vdc
Emitter – Base Voltage	V <sub>EBO</sub>	-5.0	Vdc
Collector Current – Continuous	I <sub>C</sub>	-500	mAdc
Total Device Dissipation  @ T <sub>A</sub> = 25°C  Derate above 25°C	P <sub>D</sub>	625 5.0	mW mW/°C
Total Device Dissipation @ T <sub>C</sub> = 25°C Derate above 25°C	P <sub>D</sub>	1.5 12	W mW/°C
Operating and Storage Junction Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C

## THERMAL CHARACTERISTICS

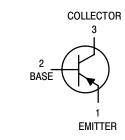
Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	200	°C/W
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	83.3	°C/W

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

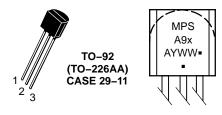


## ON Semiconductor®

#### http://onsemi.com



## **MARKING DIAGRAM**



x = 2 or 3

A = Assembly Location

Y = Year WW = Work Week ■ = Pb-Free Package

(Note: Microdot may be in either location)

## ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 3 of this data sheet.

**Preferred** devices are recommended choices for future use and best overall value.

<sup>\*</sup>For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

## **ELECTRICAL CHARACTERISTICS** ( $T_A = 25^{\circ}C$ unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit			
OFF CHARACTERISTICS							
Collector – Emitter Breakdown Voltage (Note 1) $(I_C = -1.0 \text{ mAdc}, I_B = 0)$	MPSA92 MPSA93	V <sub>(BR)CEO</sub>	-300 -200	_ _	Vdc		
Collector – Base Breakdown Voltage (I <sub>C</sub> = –100 μAdc, I <sub>E</sub> = 0)	MPSA92 MPSA93	V <sub>(BR)</sub> CBO	-300 -200	_ _	Vdc		
Emitter – Base Breakdown Voltage $(I_E = -100 \mu Adc, I_C = 0)$		V <sub>(BR)EBO</sub>	-5.0	-	Vdc		
Collector Cutoff Current $(V_{CB} = -200 \text{ Vdc}, I_E = 0)$ $(V_{CB} = -160 \text{ Vdc}, I_E = 0)$	MPSA92 MPSA93	I <sub>CBO</sub>	_ _	-0.25 -0.25	μAdc		
Emitter Cutoff Current $(V_{EB} = -3.0 \text{ Vdc}, I_C = 0)$		I <sub>EBO</sub>	_	-0.1	μAdc		
ON CHARACTERISTICS (Note 1)	ON CHARACTERISTICS (Note 1)						
DC Current Gain ( $I_C = -1.0 \text{ mAdc}$ , $V_{CE} = -10 \text{ Vdc}$ ) ( $I_C = -10 \text{ mAdc}$ , $V_{CE} = -10 \text{ Vdc}$ )	All Types All Types	h <sub>FE</sub>	25 40	- -	_		
$(I_C = -30 \text{ mAdc}, V_{CE} = -10 \text{ Vdc})$	MPSA92 MPSA93		25 25	- -			
Collector – Emitter Saturation Voltage (I <sub>C</sub> = -20 mAdc, I <sub>B</sub> = -2.0 mAdc)	MPSA92 MPSA93	V <sub>CE(sat)</sub>		-0.5 -0.4	Vdc		
Base–Emitter Saturation Voltage ( $I_C = -20 \text{ mAdc}$ , $I_B = -2.0 \text{ mAdc}$ )		V <sub>BE(sat)</sub>	_	-0.9	Vdc		
SMALL-SIGNAL CHARACTERISTICS							
Current-Gain - Bandwidth Product (I <sub>C</sub> = -10 mAdc, V <sub>CE</sub> = -20 Vdc, f = 100 MHz)		f <sub>T</sub>	50	_	MHz		
Collector–Base Capacitance (V <sub>CB</sub> = -20 Vdc, I <sub>E</sub> = 0, f = 1.0 MHz)	MPSA92 MPSA93	C <sub>cb</sub>	_ _	6.0 8.0	pF		

<sup>1.</sup> Pulse Test: Pulse Width  $\leq$  300  $\mu$ s, Duty Cycle  $\leq$  2%.

## **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
MPSA92	TO-92	5000 Units / Box
MPSA92G	TO-92 (Pb-Free)	5000 Units / Box
MPSA92RL1	TO-92	2000 / Tape & Reel
MPSA92RL1G	TO-92 (Pb-Free)	2000 / Tape & Reel
MPSA92RLRA	TO-92	2000 / Tape & Reel
MPSA92RLRAG	TO-92 (Pb-Free)	2000 / Tape & Reel
MPSA92RLRM	TO-92	2000 / Ammo Pack
MPSA92RLRMG	TO-92 (Pb-Free)	2000 / Ammo Pack
MPSA92RLRP	TO-92	2000 / Ammo Pack
MPSA92RLRPG	TO-92 (Pb-Free)	2000 / Ammo Pack
MPSA92ZL1	TO-92	2000 / Ammo Pack
MPSA92ZL1G	TO-92 (Pb-Free)	2000 / Ammo Pack
MPSA93	TO-92	5000 Units / Box
MPSA93G	TO-92 (Pb-Free)	5000 Units / Box
MPSA93RLRM	TO-92	2000 / Ammo Pack
MPSA93RLRMG	TO-92 (Pb-Free)	2000 / Ammo Pack

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

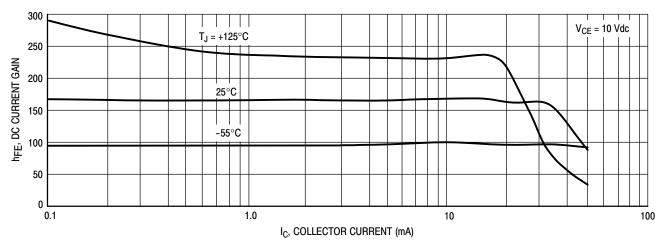


Figure 1. DC Current Gain

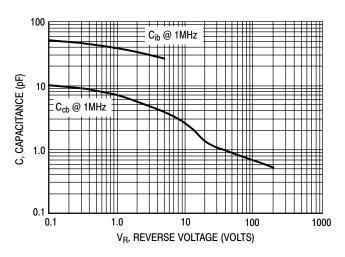


Figure 2. Capacitance

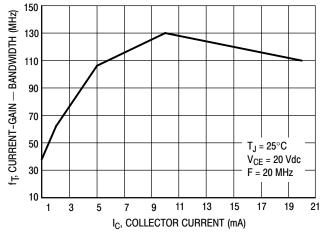


Figure 3. Current-Gain - Bandwidth

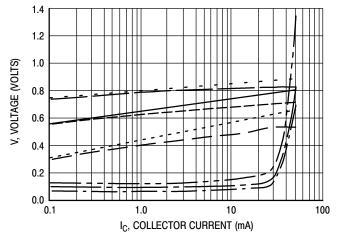
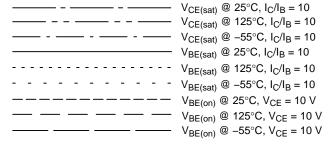
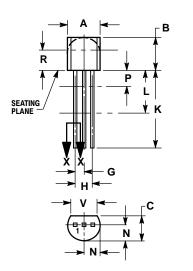


Figure 4. "ON" Voltages



## **PACKAGE DIMENSIONS**

TO-92 **TO-226AA** CASE 29-11 **ISSUE AL** 





- NOTES:
  1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: INCH.
  3. CONTOUR OF PACKAGE BEYOND DIMENSION R IS UNCONTROLLED.
  4. LEAD DIMENSION IS UNCONTROLLED IN P AND BEYOND DIMENSION K MINIMUM.

	INC	HES	MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.175	0.205	4.45	5.20
В	0.170	0.210	4.32	5.33
С	0.125	0.165	3.18	4.19
D	0.016	0.021	0.407	0.533
G	0.045	0.055	1.15	1.39
Н	0.095	0.105	2.42	2.66
J	0.015	0.020	0.39	0.50
K	0.500		12.70	
L	0.250		6.35	
N	0.080	0.105	2.04	2.66
P		0.100		2.54
R	0.115		2.93	

V	0	.135		3.43			
STYLE	1:			STYI	E 14:		
		EMIT	TER				IITTER
	2.	BASE	Ē		2.	CC	LLECTOF
	2	COLI	ECTOR		2	RΛ	CE.

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